







### J201, J202 N-Channel JFET

#### **Features**

- InterFET N0016SH Geometry
- Low Noise: 5 nV/VHz Typical
- Low Ciss: 4pF Typical
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

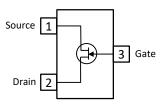
### **Applications**

- · Audio Amplifiers
- Small Signal Amplifier
- · Ultrahigh Impedance Pre-Amplifier
- •

### Description

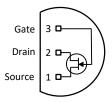
The -40V InterFET J201 and J202 are targeted for sensitive amplifier stages for mid-frequencies designs. Gate leakages are typically less than 10pA at room temperatures.

#### **SOT23 Top View**





**TO-92 Bottom View** 





#### **Product Summary**

	Parameters	J201 Min	J202 Min	Unit		
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage	-40	-40	V		
I <sub>DSS</sub>	Drain to Source Saturation Current	0.2	0.9	mA		
V <sub>GS(off)</sub>	Gate to Source Cutoff Voltage	-0.3	-0.8	V		
G <sub>FS</sub>	Forward Transconductance	500	1000	μS		

### Ordering Information Custom Part and Binning Options Available

Custom Part and Binning Options Available								
Part Number	Description	Case	Packaging					
J201; J202	Through-Hole	TO-92	Bulk					
SMPJ201; SMPJ202	Surface Mount	SOT23	Bulk					
	7" Tape and Reel: Max 3,000 Pieces		Minimum 1,000 Pieces					
SMPJ201TR; SMPJ202TR	13" Tape and Reel: Max 9,000 Pieces	SOT23	Tape and Reel					
J201COT; J202COT	Chip Orientated Tray (COT Waffle Pack)	СОТ	400/Waffle Pack					
J201CFT; J202CFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack					



**Disclaimer:** It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









### **Electrical Characteristics**

Maximum Ratings (@ T<sub>A</sub> = 25°C, Unless otherwise specified)

	Parameters	Value	Unit
$V_{RGS}$	Reverse Gate Source and Gate Drain Voltage	-40	V
I <sub>FG</sub>	Continuous Forward Gate Current	50	mA
PD	Continuous Device Power Dissipation	360	mW
Р	Power Derating	3.27	mW/°C
Τı	Operating Junction Temperature	-55 to 125	°C
T <sub>STG</sub>	Storage Temperature	-65 to 200	°C

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

			J201		J202				
	Parameters	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
V <sub>(BR)GSS</sub>	Gate to Source Breakdown Voltage	V <sub>DS</sub> = 0V, I <sub>G</sub> = -1μA	-40			-40			V
I <sub>GSS</sub>	Gate to Source Reverse Current	V <sub>GS</sub> = -20V, V <sub>DS</sub> = 0V			-100			-100	рА
V <sub>GS(OFF)</sub>	Gate to Source Cutoff Voltage	V <sub>DS</sub> = 20V, I <sub>D</sub> = 10nA	-0.3		-1.5	-0.8		-4	V
I <sub>DSS</sub>	Drain to Source Saturation Current	$V_{GS} = 0V$ , $V_{DS} = 20V$ (Pulsed)	0.2		1	0.9		4.5	mA
IG	Gate Operating Current	$V_{DG} = 20V$ , $I_D = I_{DSS(min)}$		-10			-10		рА

**Dynamic Characteristics** (@ TA = 25°C, Unless otherwise specified)

			J201		J202				
	Parameters	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
GFS	Forward Transconductance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1kHz	500			1000			μS
Gos	Output Conductance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1kHz		1			3.5		μS
Ciss	Input Capacitance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz		4			4		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz		1			1		pF
e <sub>n</sub>	Noise Voltage	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1kHz		5			5		nV/√Hz



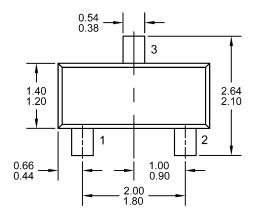


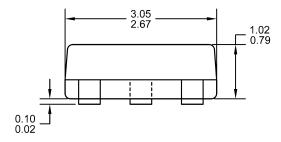


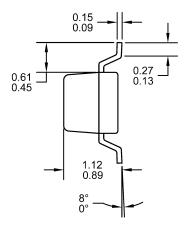


### SOT23 (TO-236AB) Mechanical and Layout Data

### **Package Outline Data**

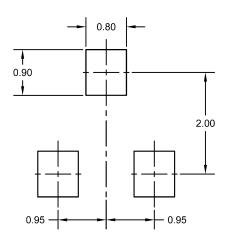






- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.12 grams
- 3. Molded plastic case UL 94V-0 rated
- For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
- Bulk product is shipped in standard ESD shipping material
- 6. Refer to JEDEC standards for additional information.

### **Suggested Pad Layout**



- 1. All linear dimensions are in millimeters.
- 2. The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.



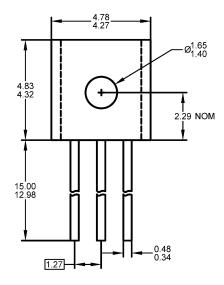


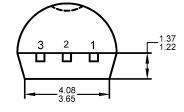


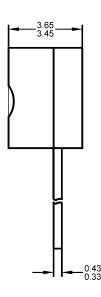


### **TO-92 Mechanical and Layout Data**

### **Package Outline Data**

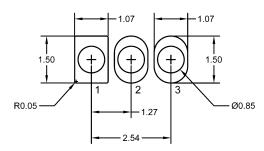






- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.19 grams
- 3. Molded plastic case UL 94V-0 rated
- Bulk product is shipped in standard ESD shipping material
- 5. Refer to JEDEC standards for additional information.

#### **Suggested Through-Hole Layout**



- 1. All linear dimensions are in millimeters.
- The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.

# **Mouser Electronics**

**Authorized Distributor** 

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## InterFET:

J202 J201 SMPJ202 SMPJ201